imall

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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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V _{CES}	650V
Ι _{C(100°C)}	50A
V _{CE(sat) (Typ.)}	1.6V
P _D	277W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating ; RoHS Compliant

Applications

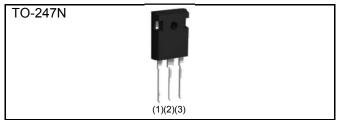
PFC

UPS

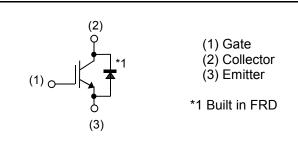
Power Conditioner

IH

Outline



Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Type	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing code	C11
	Marking	RGTH00TS65D

•Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V _{GES}	±30	V
Collector Current	$T_{\rm C}$ = 25°C	Ι _C	85	А
Collector Current	T _C = 100°C	Ι _C	50	А
Pulsed Collector Current	I _{CP} ^{*1}	200	А	
Diode Forward Current	$T_{\rm C}$ = 25°C	I _F	50	А
Diode Forward Current	T _C = 100°C	I _F	30	А
Diode Pulsed Forward Current	I _{FP} ^{*1}	200	А	
$T_c = 25^{\circ}C$		P _D	277	W
Power Dissipation	T _C = 100°C	P _D	138	W
Operating Junction Temperature	Tj	-40 to +175	°C	
Storage Temperature	T _{stg}	–55 to +175	°C	

*1 Pulse width limited by T_{jmax.}

Thermal Resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.54	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	1.42	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	cymbol Conditions		Values			
Farameter	Symbol	Conditions	Min. Typ.		Max.	Unit	
Collector - Emitter Breakdown Voltage	BV _{CES}	I _C = 10μΑ, V _{GE} = 0V	650	-	-	V	
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	10	μA	
Gate - Emitter Leakage Current	I _{GES}	V _{GE} = ±30V, V _{CE} = 0V	-	-	±200	nA	
Gate - Emitter Threshold Voltage	V _{GE(th)}	V _{CE} = 5V, I _C = 34.7mA	4.5	5.5	6.5	V	
Collector - Emitter Saturation Voltage	V _{CE(sat)}	I _C = 50A, V _{GE} = 15V T _j = 25°C T _j = 175°C	-	1.6 2.1	2.1 -	V	

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	Symbol	Symbol		Values		
Parameter	Symbol	Conditions	Min. Typ. Max.		Max.	- Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	2740	-	
Output Capacitance	C _{oes}	V _{GE} = 0V	-	106	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	43	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	94	-	
Gate - Emitter Charge	Q_{ge}	I _C = 50A	-	22	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	31	-	
Turn - on Delay Time	t _{d(on)}	I _C = 50A, V _{CC} = 400V	-	39	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	63	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 25°C	-	143	-	ns
Fall Time	t _f	t _f Inductive Load - 50		50	-	
Turn - on Delay Time	t _{d(on)}	I _C = 50A, V _{CC} = 400V	-	39	-	
Rise Time	t _r	V _{GE} = 15V, R _G = 10Ω	-	63	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	159	-	ns
Fall Time	t _f	Inductive Load	-	62	-	
		I _C = 200A, V _{CC} = 520V		-		
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650V, V_{GE} = 15V$ FULL SQUARE		RE	-	
		R _G = 60Ω, T _j = 175°C				

•IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	Parameter Symbol Conditions		Values			Linit
Parameter			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V _F	I _F = 30A T _j = 25°C T _j = 175°C	-	1.45 1.25	2.0	V
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	54	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs T _j = 25°C	-	7.4	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.22	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	225	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	V _{CC} = 400V di _F /dt = 200A/µs	-	12.8	-	А
Diode Reverse Recovery Charge	Q _{rr}	T _j = 175°C	-	1.60	-	μC

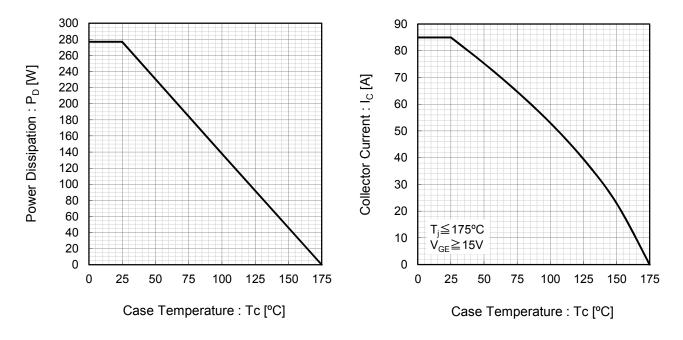
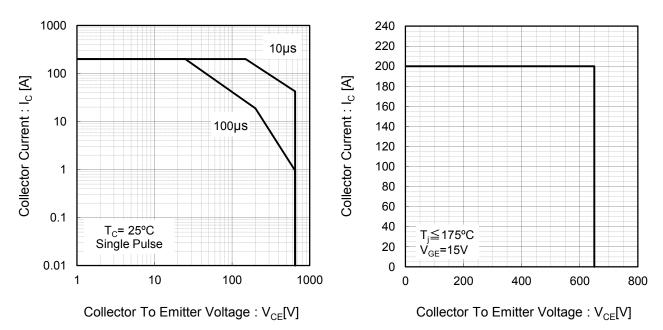


Fig.1 Power Dissipation vs. Case Temperature

Fig.2 Collector Current vs. Case Temperature

Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area



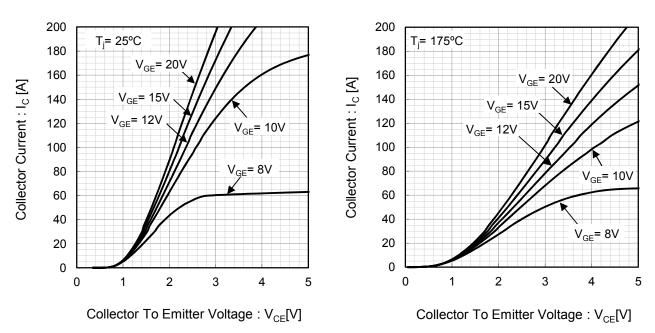
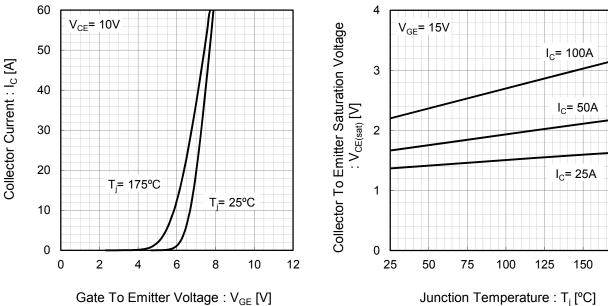


Fig.5 Typical Output Characteristics

Fig.7 Typical Transfer Characteristics

Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

Fig.6 Typical Output Characteristics



175

Fig.10 Typical Collector To Emitter Saturation Voltage

•Electrical Characteristic Curves

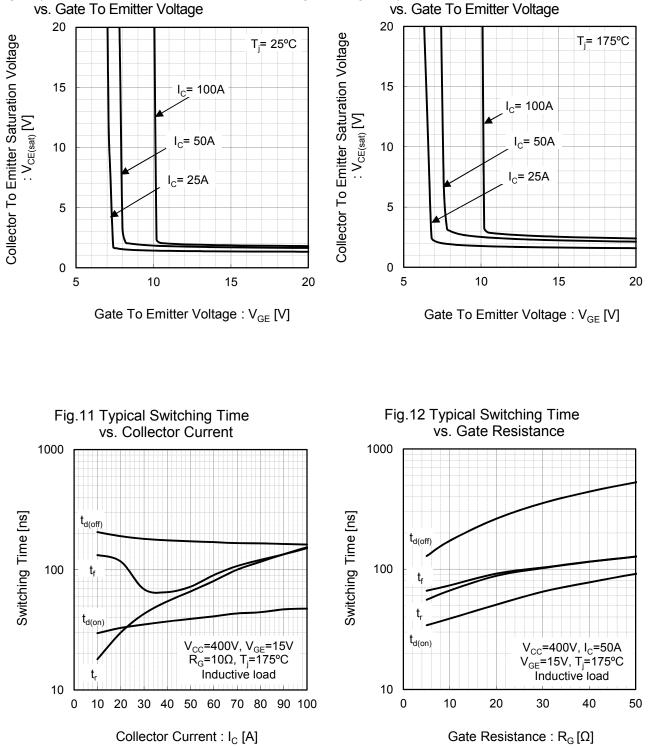
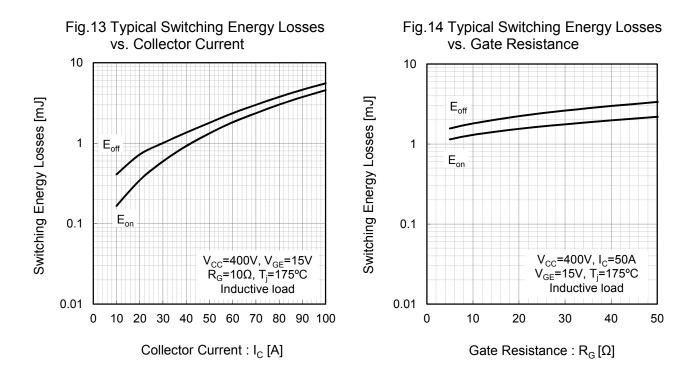


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



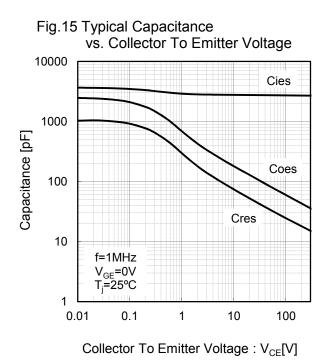
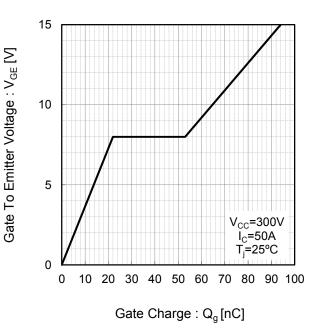


Fig.16 Typical Gate Charge



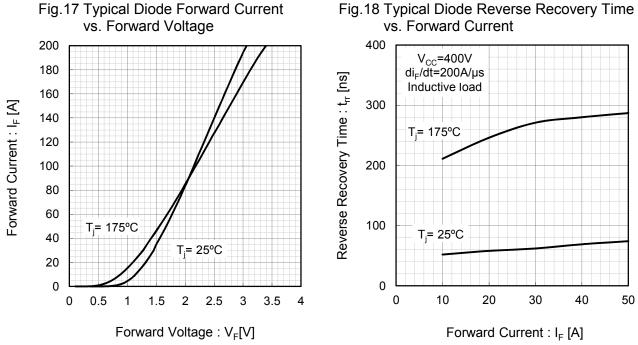


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

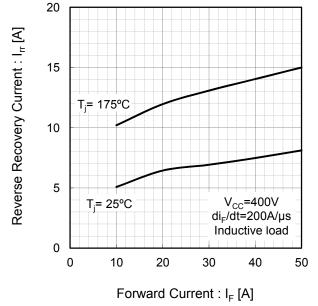
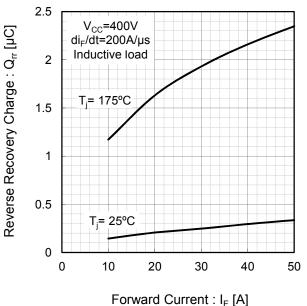
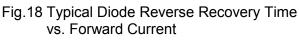


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current





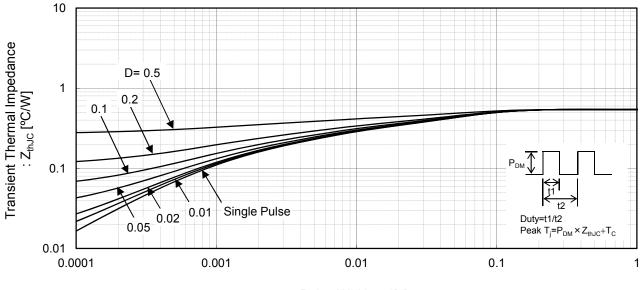


Fig.21 IGBT Transient Thermal Impedance

Pulse Width : t1[s]

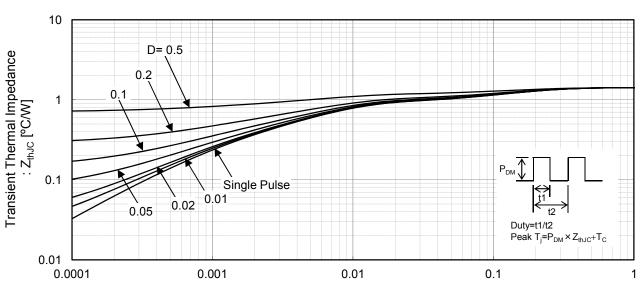


Fig.22 Diode Transient Thermal Impedance

Pulse Width : t1[s]

●Inductive Load Switching Circuit and Waveform

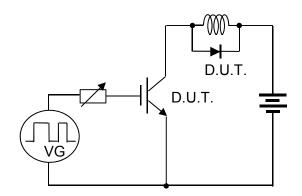


Fig.23 Inductive Load Circuit

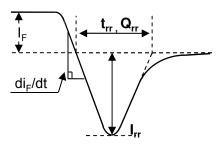


Fig.25 Diode Reverce Recovery Waveform

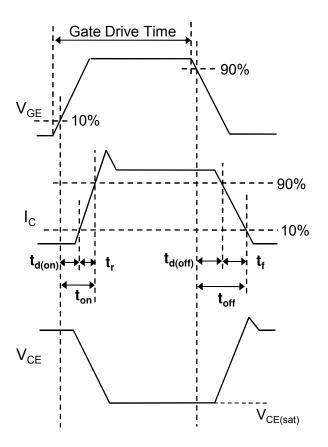


Fig.24 Inductive Load Waveform

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RGTH00TS65D - Web Page

Distribution Inventory

Part Number	RGTH00TS65D
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes